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FAIRCHILD

FQD7P06 P-Channel QFET[®] MOSFET - 60 V, - 5.4 A, 450 mΩ

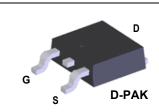
Description

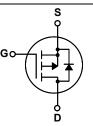
This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor[®]'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

• -5.4 A, -60 V, $R_{DS(on)}$ = 450 m Ω (Max.) @ V_{GS} = -10 V, I_D = -2.7 A

Features

- Low Gate Charge (Typ. 6.3 nC)
- Low Crss (Typ. 25 pF)
- 100% Avalanche Tested





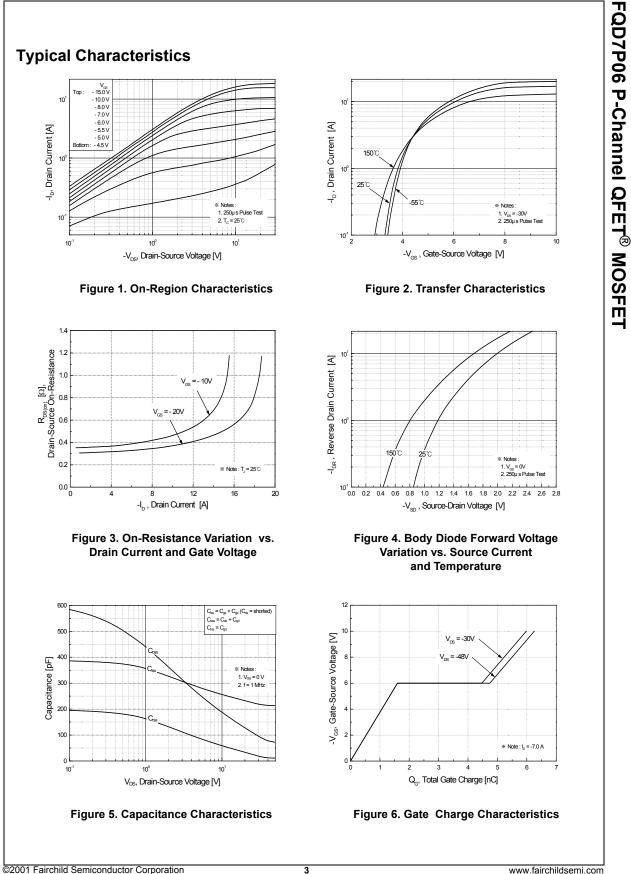
Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQD7P06	Unit	
V _{DSS}	Drain-Source Voltage		-60	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		°C)	-5.4	А
		- Continuous (T _C = 10	0°C)	-3.42	А
I _{DM}	Drain Current	- Pulsed	(Note 1)	-21.6	А
V _{GSS}	Gate-Source Voltage		± 25	V	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	90	mJ
I _{AR}	Avalanche Current		(Note 1)	-5.4	А
E _{AR}	Repetitive Avala	anche Energy	(Note 1)	2.8	mJ
dv/dt	Peak Diode Re	covery dv/dt	(Note 3)	-7.0	V/ns
P _D	Power Dissipation (T _A = 25°C) *			2.5	W
-	Power Dissipation (T _C = 25°C)			28	W
- Derate above 25°C			0.22	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds			300	°C

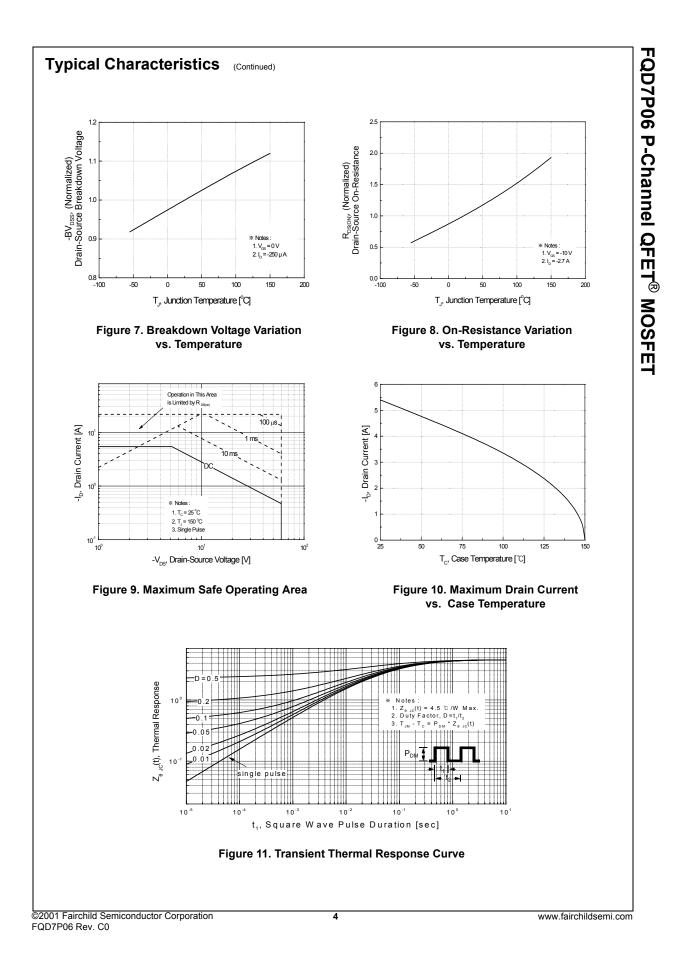
Thermal Characteristics

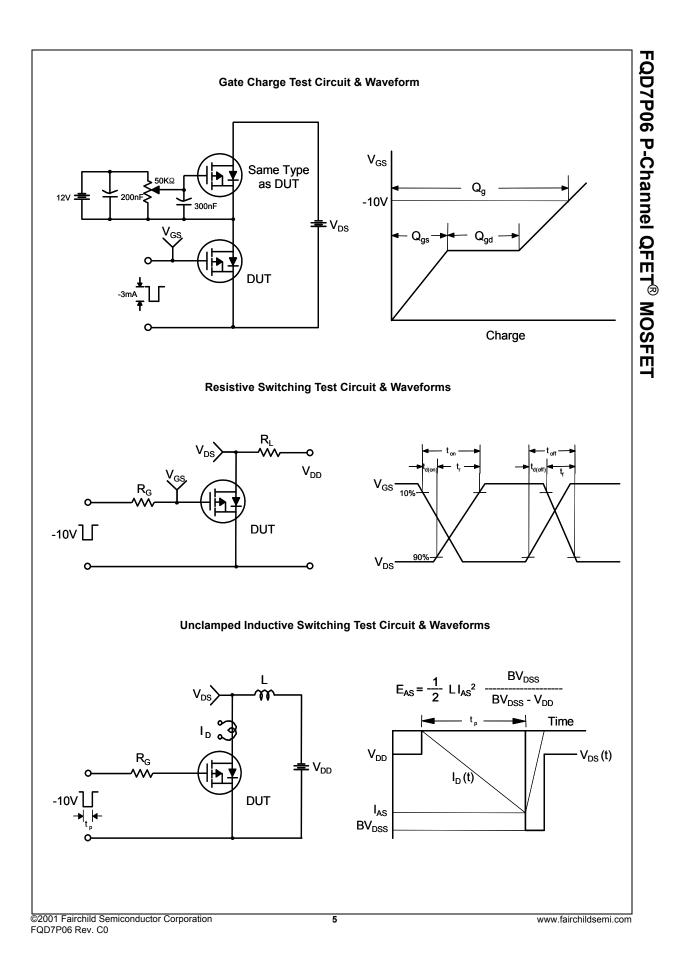
Symbol	Parameter	FQD7P06	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	4.5	°C/W	
R_{\thetaJA}	Thermal Resistance, Junction-to-Ambient *	50	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	110	°C/W	

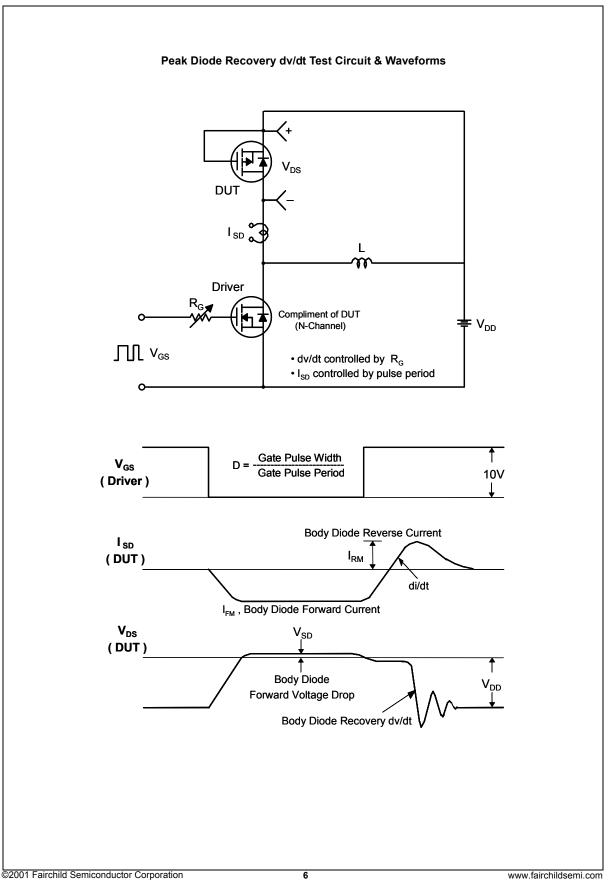
racteristics	Test Conditions	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA	-60			V
Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-0.07		V/°C
	V _{DS} = -60 V, V _{GS} = 0 V			-1	μA
Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 125°C			-10	μA
Gate-Body Leakage Current, Forward	V_{GS} = -25 V, V_{DS} = 0 V			-100	nA
Gate-Body Leakage Current, Reverse	V_{GS} = 25 V, V_{DS} = 0 V			100	nA
ractoristics					
	V _{DS} = V _{GS} , I _D = -250 μA	-2.0		-4.0	V
Static Drain-Source	V _{GS} = -10 V, I _D = -2.7 A		0.36	0.451	Ω
	$V_{DS} = -30 \text{ V}$ Ip = -2.7 A		3.8		S
c Characteristics					
Input Capacitance	$V_{D0} = -25 V V_{00} = 0 V$		225	295	pF
Output Capacitance	f = 1.0 MHz		110	145	pF
Reverse Transfer Capacitance			25	32	pF
Turn-On Delay Time Turn-On Rise Time	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -3.5 \text{ A},$ Bo = 25 Q		7 50	25 110	ns ns
$R_{G} = 23.52$			50	110	ns
Turn-Off Delay Time			75	25	ns
Turn-Off Delay Time	(Note 4)		7.5 25	25 60	ns ns
Turn-Off Fall Time	(Note 4)		25	60	ns
Turn-Off Fall Time Total Gate Charge	(Note 4) V _{DS} = -48 V, I _D = -7.0 A,		25 6.3		ns nC
Turn-Off Fall Time	(Note 4)		25	60 8.2	ns
Turn-Off Fall Time Total Gate Charge Gate-Source Charge	(Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_D = -7.0 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4)		25 6.3 1.6	60 8.2 	ns nC nC
Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Diode F	(Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_D = -7.0 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) nd Maximum Ratings ode Forward Current Forward Current		25 6.3 1.6	60 8.2 	ns nC nC
Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Diode F	(Note 4) $V_{DS} = -48 \text{ V}, I_D = -7.0 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) nd Maximum Ratings bde Forward Current Forward Current $V_{GS} = 0 \text{ V}, I_S = -5.4 \text{ A}$		25 6.3 1.6	60 8.2 	ns nC nC nC
Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Source Diode Characteristics an Maximum Continuous Drain-Source Diode F	(Note 4) $V_{DS} = -48 \text{ V}, \text{ I}_D = -7.0 \text{ A},$ $V_{GS} = -10 \text{ V}$ (Note 4) nd Maximum Ratings ode Forward Current Forward Current		25 6.3 1.6	60 8.2 	ns nC nC nC A A
	Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse racteristics Gate Threshold Voltage Static Drain-Source On-Resistance Forward Transconductance c Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	VDS= -48 V, I_C = 125°CGate-Body Leakage Current, Forward $V_{GS} = -25 V, V_{DS} = 0 V$ Gate-Body Leakage Current, Reverse $V_{GS} = 25 V, V_{DS} = 0 V$ racteristics $V_{GS} = 25 V, V_{DS} = 0 V$ Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = -250 \mu A$ Static Drain-Source $V_{GS} = -10 V, I_D = -2.7 A$ On-Resistance $V_{DS} = -30 V, I_D = -2.7 A$ Forward Transconductance $V_{DS} = -30 V, I_D = -2.7 A$ Input Capacitance $V_{DS} = -25 V, V_{GS} = 0 V, I_D = -2.7 A$ Input Capacitance $V_{DS} = -25 V, V_{GS} = 0 V, I_D = -2.7 A$ Reverse Transfer Capacitance $V_{DS} = -25 V, V_{GS} = 0 V, I_D = -2.7 A$ mg CharacteristicsInput CapacitanceTure On Dalay TimeInput Capacitance	VDS= -48 V, $I_C = 125^{\circ}C$ Gate-Body Leakage Current, Forward $V_{GS} = -25 V, V_{DS} = 0 V$ Gate-Body Leakage Current, Reverse $V_{GS} = 25 V, V_{DS} = 0 V$ racteristics $V_{DS} = V_{GS}, I_D = -250 \mu A$ -2.0Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = -250 \mu A$ -2.0Static Drain-Source $V_{GS} = -10 V, I_D = -2.7 A$ On-Resistance $V_{DS} = -30 V, I_D = -2.7 A$ Forward Transconductance $V_{DS} = -30 V, I_D = -2.7 A$ c CharacteristicsInput Capacitance $V_{DS} = -25 V, V_{GS} = 0 V, I_D = -2.7 A$ Output Capacitance $V_{DS} = -25 V, V_{GS} = 0 V, I_D = -2.7 A$ ng CharacteristicsTure On Delay Time	VDS= -48 V, I_C = 125°CGate-Body Leakage Current, Forward $V_{GS} = -25 V, V_{DS} = 0 V$ Gate-Body Leakage Current, Reverse $V_{GS} = 25 V, V_{DS} = 0 V$ racteristicsGate Threshold Voltage $V_{DS} = V_{GS}, I_D = -250 \mu A$ -2.0Static Drain-Source $V_{GS} = -10 V, I_D = -2.7 A$ 0.36On-Resistance $V_{DS} = -30 V, I_D = -2.7 A$ 3.8c CharacteristicsInput Capacitance $V_{DS} = -25 V, V_{GS} = 0 V,$ 225Output Capacitance $f = 1.0 MHz$ 110Reverse Transfer Capacitance $$ 25mg Characteristics	$V_{DS} = -48 \text{ V}, 1_C = 125^{\circ}\text{C}$ 10 Gate-Body Leakage Current, Forward $V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$ -100 Gate-Body Leakage Current, Reverse $V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$ 100 racteristics Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = -250 \mu \text{ A}$ 4.0 Static Drain-Source $V_{GS} = -10 \text{ V}, I_D = -2.7 \text{ A}$ 0.36 0.451 Forward Transconductance $V_{DS} = -30 \text{ V}, I_D = -2.7 \text{ A}$ 3.8 c Characteristics Input Capacitance $V_{DS} = -30 \text{ V}, I_D = -2.7 \text{ A}$ 3.8 c Characteristics Input Capacitance $V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ 225 295 Output Capacitance $V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ 110 145 Reverse Transfer Capacitance 25 32 32 Ture On Delay Line



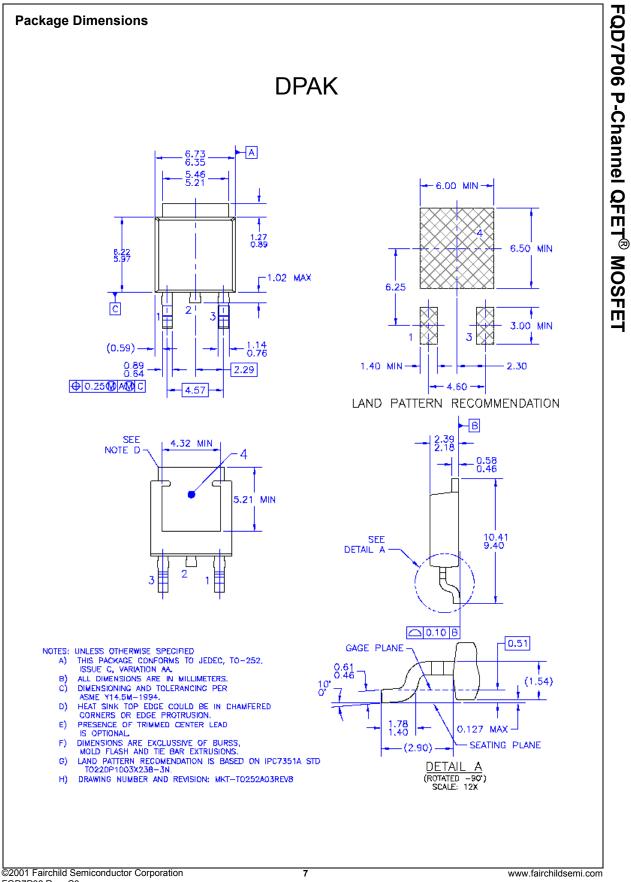
FQD7P06 Rev. C0







FQD7P06 P-Channel QFET® MOSFET





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